

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Chopra et al.

**Serial No.:** 10/620,002

**Filed:** July 14, 2003

**For:** SLURRY FOR USE WITH FIXED-  
ABRASIVE POLISHING PADS IN  
POLISHING SEMICONDUCTOR DEVICE  
CONDUCTIVE STRUCTURES THAT  
INCLUDE COPPER AND A COPPER  
BARRIER (as amended)

**Confirmation No.:** 7481

**Examiner:** L. Umez-Eronini

**Group Art Unit:** 1792

**Attorney Docket No.:** 2269-4373.2US  
(00-0036.02/US)

VIA ELECTRONIC FILING  
January 11, 2008

**RESPONSE**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Examiner:

This Response follows the Office Action mailed of October 11, 2007, the shortened statutory period for response to which expires on January 11, 2008.